

IO-Link Smart Sensor Profile

Specification

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1 **0 Introduction**

2 **0.1 General**

3 The Single-drop Digital Communication Interface (SDCI) and system technology (IO-Link™¹)
4 for low-cost sensors and actuators is standardized within IEC 61131-9 [1]. The technology is
5 an answer to the need of these digital/analog sensors and actuators to exchange process
6 data, diagnosis information and parameters with a controller (PC or PLC) using a low-cost,
7 digital communication technology while maintaining backward compatibility with the current
8 DI/DO signals as defined in IEC 61131-2.

9 Any SDCI compliant Device can be attached to any available interface port of an SDCI Mas-
10 ter. SDCI compliant devices perform physical to digital conversion in the device, and then
11 communicate the result directly in a standard 24 V I/O digital format, thus removing the need
12 for different DI, DO, AI, AO modules and a variety of cables.

13 Physical topology is point-to-point from each Device to the Master using 3 wires over dis-
14 tances up to 20 m. The SDCI physical interface is backward compatible with the usual
15 24 V I/O signalling specified in IEC 61131-2. Transmission rates of 4,8 kbit/s, 38,4 kbit/s and
16 230,4 kbit/s are supported.

17 Tools allow the association of Devices with their corresponding electronic I/O device descrip-
18 tions (IODD) and their subsequent configuration to match the application requirements [2].

19 This document describes a common part of a sensor model that should be valid for future De-
20 vice profiles and a more specific part for so-called Smart Sensors.

21 This document follows the IEC 62390 [3] to a certain extent.

22 Terms of general use are defined in IEC 61131-1 or in [4]. Specific SDCI terms are defined in
23 this part.

24 **0.2 Patent declaration**

25 There are no known patents related to the content of this document.

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PROGRAMMABLE CONTROLLERS —

Profile for Smart Sensor Devices according IEC 61131-9 (Single-drop Digital Communication Interface – SDCI)

36 **1 Scope**

37 The single-drop digital communication interface (SDCI) technology described in part 9 of the
38 IEC 61131 series focuses on simple sensors and actuators in factory automation, which are
39 nowadays using small and cost-effective microcontrollers. With the help of the SDCI technol-
40 ogy, the existing limitations of traditional signal connection technologies such as switching
41 0/24 V, analog 0 to 10 V, etc. can be turned into a smooth migration. Classic sensors and ac-
42 tuators are usually connected to a fieldbus system via input/output modules in so-called re-
43 mote I/O peripherals. The (SDCI) Master function enables these peripherals to map SDCI De-
44 vices onto a fieldbus system or build up direct gateways. Thus, parameter data can be trans-
45 ferred from the PLC level down to the sensor/actuator level and diagnosis data transferred
46 back in turn by means of the SDCI communication. This is a contribution to consistent pa-
47 rameter storage and maintenance support within a distributed automation system. SDCI is
48 compatible to classic signal switching technology according to part 2 of the IEC 61131 series.

49 This document defines the common characteristics of SDCI Device profiles before it defines
50 the model of a so-called Smart Sensor. This model comprises process data structures, identi-
51 fication objects, binary switching thresholds and hysteresis, best practice handling of quantity
52 measurements with or without associated units, diagnosis objects, and teaching commonal-
53 ities.

54 This document contains statements on conformity testing for Smart Sensor Devices and pro-
55 file specific IODD features.

56 **2 Normative references**

57 The following referenced documents are indispensable for the application of this document.
58 For dated references, only the edition cited applies. For undated references, the latest edition
59 of the referenced document (including any amendments) applies.

60 IEC 61131-2, *Programmable controllers – Part 2: Equipment requirements and tests*

61 IEC 61131-9, *Programmable controllers – Part 9: Single-drop digital communication interface
62 for small sensors and actuators (SDCI)*

63 **3 Terms, definitions, symbols, abbreviated terms and conventions**

64 **3.1 Terms and definitions**

65 For the purposes of this document, the following terms and definitions in addition to those
66 given in IEC 61131-1, IEC 61131-2, and IEC 61131-9 apply.

67 **3.1.1**

68 **BinaryDataChannel (BDC)**

69 threshold information for binary signals in switching mode

70 **3.1.2**

71 **block parameter**

72 consistent parameter access via multiple Indices or Subindices

73 **3.1.3**74 **coded switching**

75 SDCI communication, based on the standard binary signal levels of IEC 61131-2

76 **3.1.4**77 **communication channel**

78 logical connection between Master and Device

79 NOTE Four communication channels are defined: process channel, page and ISDU channel (for parameters) and
80 diagnosis channel.

81 **3.1.5**82 **Device**

83 single passive peer to a Master such as a sensor or actuator

84 NOTE Uppercase "Device" is used for SDCI equipment, while lowercase "device" is used in a generic manner.

85 **3.1.6**86 **event**

87 an instance of a change of conditions

88 NOTE An event is indicated via the event flag within the Device's status cyclic information, then acyclic transfer of
89 event data (typically diagnosis information) is conveyed through the diagnosis communication channel.

90 [IEC 61158-5-x, modified]

91 **3.1.7**92 **FunctionClass**

93 particular function within a Device profile

94 NOTE A profile Device can use one or several FunctionClasses one or several times.

95 **3.1.8**96 **ISDU**

97 indexed service data unit used for acyclic acknowledged transmission of parameters that can
98 be segmented in a number of F-sequences

99 **3.1.9**100 **Master**

101 active peer connected through ports to one up to n Devices and which provides an interface
102 to the gateway to the upper level communication systems or PLCs

103 NOTE Uppercase "Master" is used for SDCI equipment, while lowercase "master" is used in a generic manner.

104 **3.1.10**105 **on-request data (OD)**

106 acyclically transmitted data upon request of the Master application consisting of parameters
107 or event data

108 **3.1.11**109 **port**

110 communication medium interface of the Master to one Device

111 **3.1.12**112 **process data (PD)**

113 input or output values from or to a discrete or continuous automation process cyclically trans-
114 ferred with high priority and in a configured schedule automatically after start-up of a Master

115 **3.1.13**116 **ProcessDataVariable (PDV)**

117 representation of a measurement value

- 118 **3.1.14**
119 **process variable input descriptor (PVinD)**
120 descriptor for position and offset of variables within the Process (input) Data entity
- 121 **3.1.15**
122 **process variable output descriptor (PVoutD)**
123 descriptor for position and offset of variables within the Process (output) Data entity
- 124 **3.1.16**
125 **ProfileIdentifier**
126 list of supported profiles and function classes
- 127 **3.1.17**
128 **Setpoint**
129 threshold measurement value of a sensor for the rising or falling edge of a binary output signal
130
- 131 **3.1.18**
132 **single point mode**
133 evaluation method with one single Setpoint where the binary output signal changes whenever
134 the sensor signal passes above or below this Setpoint
- 135 **3.1.19**
136 **SIO**
137 port operation mode in accordance with digital input and output defined in IEC 61131-2 that is
138 established after power-up or fallback or unsuccessful communication attempts
- 139 **3.1.20**
140 **switching mode**
141 one out of a set of possible operational modes for binary signals such as 'deactivated', 'Single
142 Point Mode', 'Window Mode', or 'Two Point Mode'
- 143 NOTE Vendor specific modes are possible.
- 144 **3.1.21**
145 **switching signal**
146 binary signal from or to a Device when in SIO mode (as opposed to the "coded switching"
147 SDCI communication)
- 148 **3.1.22**
149 **switchpoint**
150 measurement value of a sensor where the binary output signal changes its value
- 151 **3.1.23**
152 **Teach Flag**
153 indication for the success of a Teachpoint setting
- 154 **3.1.24**
155 **Teachpoint**
156 trigger to set a threshold value or the border value of a range
- 157 **3.1.25**
158 **Teach State**
159 indication of the current state of the teach-in procedure

160 **3.1.26**
 161 **two point mode**
 162 evaluation method with two Setpoints where the binary output signal only changes if the sen-
 163 sor measurement value comes from above the highest Setpoint and passes the lowest Set-
 164 point or if it comes from below the lowest Setpoint and passes the highest Setpoint

165 **3.1.27**
 166 **wake-up**
 167 procedure for causing a Device to change its mode from SIO to COMx

168 **3.1.28**
 169 **window mode**
 170 evaluation with two Setpoints where the binary output signal depends on the measurement
 171 value of the sensor being between the Setpoints or either above the highest or below the low-
 172 est Setpoint

173

174 **3.2 Symbols and abbreviated terms**

DI	Digital input	
DO	Digital output	
I/O	Input / output	
OD	On-request Data	
PD	Process Data	
PLC	Programmable logic controller	
SDCI	Single-drop digital communication interface	
SIO	Standard Input Output (binary switching signal)	[IEC 61131-2]
SP1	Setpoint 1 (rising edge)	
SP2	Setpoint 2 (falling edge)	
TP1	Teachpoint 1 (rising edge or lower border)	
TP2	Teachpoint 2 (falling edge or higher border)	

175

176 **3.3 Conventions**

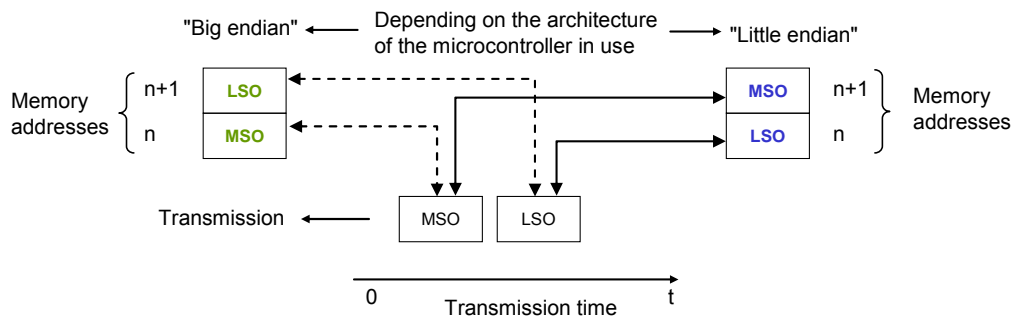
177 **3.3.1 Behavioral descriptions**

178 For the behavioral descriptions, the notations of UML 2 [4] are used, mainly state diagrams.
 179 The layout of the associated state-transition tables is following IEC 62390 [3].

180 The state diagrams shown in this document are entirely abstract descriptions. They do not
 181 represent a complete specification for implementation.

182 **3.3.2 Memory and transmission octet order**

183 Figure 1 demonstrates the order that shall be used when transferring WORD based data types
 184 from memory to transmission and vice versa (Figure 1).



185

186

Figure 1 – Memory and transmission octet order

187 4 Overview of sensor devices

188 4.1 Smart Sensors

189 In factory automation, sensors nowadays are using a broad spectrum of transducers based on
 190 many different physical or chemical effects. They are converting one or more physical or
 191 chemical quantities (for example position, pressure, temperature, substance, etc.) and propa-
 192 gate them in an appropriate form to data processing units such as for example PLCs.

193 Due to the built-in microcontrollers these sensors are able to not only provide the conversion
 194 of the quantities but also to provide some preprocessing. Most of these sensors are "switch-
 195 point sensors". With the help of an individual parameterization or teaching process ("teach-
 196 in"), the sensors receive information on their "switching mode" and the threshold values ("Set-
 197 points"). This can result in one or more binary information about the measured quantity. De-
 198 pending on functionality, those sensors provide the following outputs

- 199 • Binary information to transfer a switching state and/or
- 200 • Analog information to transfer measurement values such as pressure or temperature

201 This widespread sensor type is called "Smart Sensor". It has been somewhat "handicapped"
 202 so far by the restrictions of conventional digital and analog interfaces defined in IEC 61131-2.

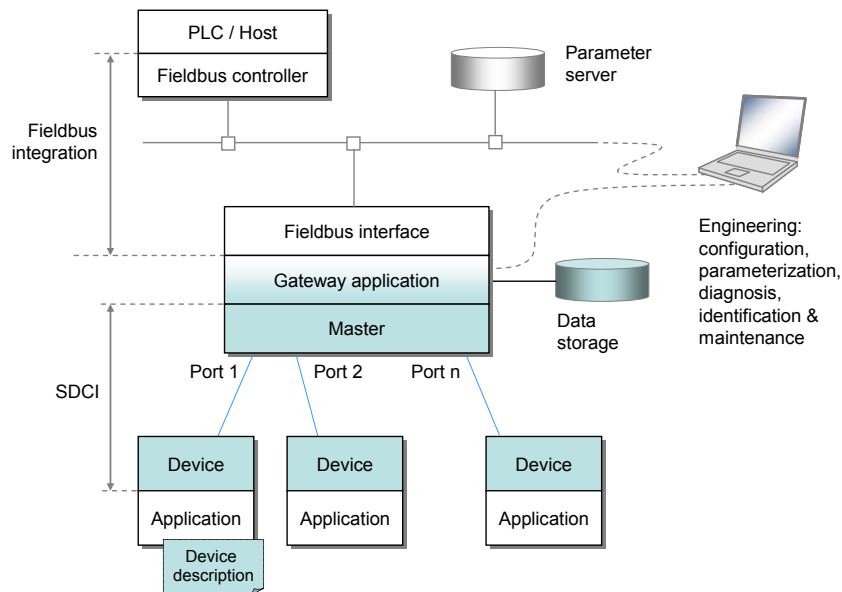
203 4.2 Sensors migrating to SDCI

204 It is the purpose of SDCI to overcome the limitations of the classic sensor interfaces DI, DO,
 205 AI, and AO via a point-to-point digital communication that allows transmitting not only binary
 206 and/or analog information but additional information also. Very often, the changes to the core
 207 sensor application ("sensor technology") are very little during the migration to SDCI. However,
 208 the user realizes a dramatic increase in comfort and flexibility through the identification,
 209 parameterization, and diagnosis features.

210 5 Device profiles related to IEC 61131-9

211 5.1 SDCI technology specified in IEC 61131-9

212 Figure 2 shows the domain of the SDCI technology within the automation hierarchy.



213

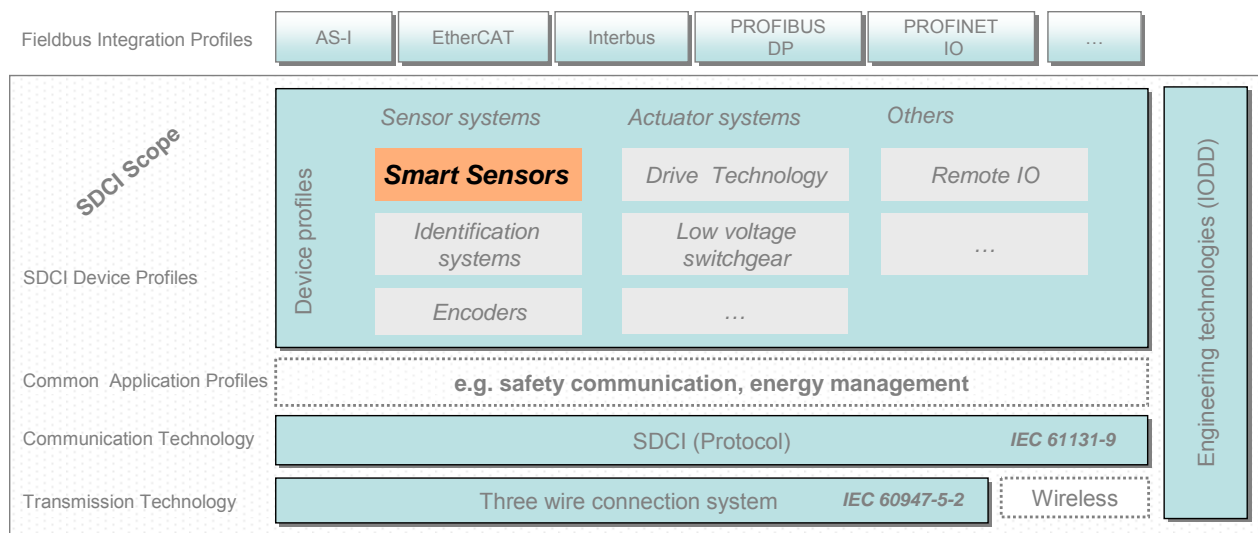
214

Figure 2 – Domain of the SDCI technology within the automation hierarchy

215 The SDCI technology defines a point-to-point digital communication interface for connecting
 216 "digital" or "analog" type sensors and actuators to a Master unit, which can be combined with
 217 gateway capabilities to become a fieldbus remote I/O node. The technology is specified in [1]
 218 and [2].

219 **5.2 Profile classification**

220 Figure 3 shows an overview of the SDCI technologies and profiles.



221

222

Figure 3 – Overview of SDCI technologies and profiles

223 The "SDCI Device Profiles" represent specifications of common functionality of particular De-
 224 vice type families/classes such as drives, low voltage switch gears, encoders, etc. These pro-
 225 files primarily focus on the structure and behavior of the Device technology and secondarily
 226 on the data mapping on SDCI. Thus, the user recognizes a "generic" Device to a certain ex-
 227 tent even when he switches from one brand to another.

228 The "Common Application Profiles" represent specifications that several Device type families/
 229 classes can use. Examples are safety communication protocols or energy management.

230 The "Fieldbus Integration Profiles" specify the adaptation of the SDCI technology to particular
 231 fieldbuses. These specifications are outside the responsibility of the organization listed in
 232 Annex B. However, this organization is interested in harmonizing the "views" of SDCI users
 233 through the different fieldbuses.

234 **5.3 Profile related Index space**

235 The SDCI technology holds Indices and Subindices within Devices to store and/or retrieve
 236 parameter objects. Table 1 shows the profile related Indices defined in [1]. This profile speci-
 237 fication overwrites some of the definitions in the standard, for example the ProductID, which is
 238 mandatory for Smart Sensors.

239 **Table 1 – Excerpt of the SDCI Indices related to profiles**

Index (dec)	Object name	Access	Length	Data type	M/O/C	Smart Sensor profile definitions
...						
0x0002 (2)	System Command	W	1 octet	UIntegerT	M/O	See Table 13
...						
0x000D (13)	Profile Characteristic	R	variable	ArrayT of UIntegerT16	M	See Table 3
0x000E (14)	PDInput Descriptor	R	variable	ArrayT of OctetStringT3	M	See Table 7
0x000F (15)	PDOutput Descriptor	R	variable	ArrayT of OctetStringT3	M	Not used in this Smart Sensor profile
...						
0x0013 (19)	Product ID	R	Max. 64 octets	StringT	M	See Table 9
...						
0x0017 (23)	Firmware Revision	R	Max. 64 octets	StringT	M	See Table 9
0x0018 (24)	Application Specific Tag	R/W	Min. 16, max. 32 octets	StringT	M	See Table 9
...						
0x0024 (36)	Device Status	R	1 octet	UIntegerT	O	See clause 11
0x0025 (37)	Detailed Device Status	R	variable	ArrayT of OctetStringT3	O	See clause 11
...						
0x0031 to 0x003F (49 to 63)	Reserved for profiles					Teach-in Channel and Teach-in Status BDC1 and BDC2 Index space See clause 12 and Table 11
...						
0x4000 to 0x4FFF (16384 to 20479)	Profile specific Index					Index space for BDC3 to BDC128. See 9.3.2
Key M = mandatory; O = optional; C = conditional						

240

241 **5.4 Profile characteristics**

242 All SDCI Device Profiles shall be characterized within the parameter object "Profile Character-
 243 istic" in Index 0x000D via ProfileIdentifiers (PID) listed within an array. Normally, an SDCI de-
 244 vice supports only one SDCI Device Profile (e.g. this Smart Sensor Profile). It is also possible
 245 for an SDCI device to support several Common Application Profiles as well as several Func-

246 tionClasses (see 6.4). FunctionClasses defined in this profile can also be inherited to other
 247 SDCI device profiles, for example to SDCI actuators.

248 The individual PID describes a particular profile and its supported functions via the following
 249 IDs:

- 250 • DeviceProfileID
- 251 • CommonApplicationProfileID
- 252 • FunctionClassID

253 The parameter object "Profile Characteristic" supports up to 32 ID entries. Each and every
 254 supported profile and FunctionClass shall be indicated and coded as specified in Table 2.

255 **Table 2 – Coding of ProfileIdentifiers (PID)**

Parameter object name	Data type	Value range	Profile type
ProfileIdentifier (PID)	UIntegerT16	0x0000	No profile supported
		0x0001 to 0x3FFF	DeviceProfileID
		0x4000 to 0x7FFF	CommonApplicationProfileID
		0x8000 to 0xBFFF	FunctionClassID
		0xC000 to 0xFFFF	Reserved

256 The following rules apply:

- 257 1) Whenever a Device profile is supported such as for example "Smart Sensors", it shall be indicated via a De-
 viceProfileID entry
- 258 2) Whenever 1 to n common application profiles are supported, they shall be indicated via 1 to n CommonAp-
 plicationProfileIDs
- 259 3) Whenever 1 to n functions are supported, they shall be indicated via 1 to n FunctionClassIDs
- 260 4) The IDs shall be listed in ascending order (DeviceProfileIDs → CommonApplicationProfileIDs → Function-
 ClassIDs)

261 **Figure 4 – Indication rules for ProfileIdentifiers**

262 The different profile identifiers shall be ordered within the array of the parameter object "Pro-
 263 file Characteristic" in a sequence shown in Table 2 using the SDCI Subindices as a reference.

264 Table 3 shows the example for the "Profile Characteristic" of a Smart Sensor

265 **Table 3 – Example of the profile identification for a Smart Sensor**

Index	Sub-index	ProfileID	R/W	Data Type	Example ID
0x000D	1	Profile Identifier (DeviceProfileID)	R	UIntegerT16	0x0001: Smart Sensor Profile
	2	Profile Identifier (FunctionClassID)	R		0x8001: Binary data channel
	3	Profile Identifier (FunctionClassID)	R		0x8002: Process value
	4	Profile Identifier (FunctionClassID)	R		0x8004: Teach Channel

266

267 **5.5 User benefits**

268 As already mentioned in 5.2 the user recognizes from the Masters point of view a "generic"
 269 Device through the communication interface even when he switches from one brand to an-
 270 other. The exchange of process data and the behavior of the profile Device are the same, at
 271 least for "basic" functions. That means he is not forced to change his user program within the
 272 controller (PLC) in this case and he can expect the same basic behavior of the Device (for

273 example process data, diagnosis, and identification). However, due to the objectives for the
 274 individual Device profiles, the interoperability levels can be different and the compatibility be-
 275 tween the profile Devices can be partly limited. A good compromise is the possibility of read-
 276 ing the profile features out of the Device via the PLC program and adjusting the user program
 277 accordingly. Such a solution is the Smart Sensor profile defined in the following.

278 6 Smart Sensor profile

279 6.1 Objectives for the Smart Sensor profile

280 As mentioned in 5.5 the user expects a common "view" on a profile device and therefore he
 281 requires standardized functions. On the other hand, he expects innovations and customer
 282 specific adaptations to a certain extent. With this background, Device profiles are always a
 283 challenge and they are striving for good compromises. The Smart Sensor Device group com-
 284 piled the following requirements and objectives for the profile:

- 285 • Manufacturer/vendor specific extensions (functions) shall always be possible
- 286 • The standardized profile functions (FunctionClasses) specified within this document are
 287 optional. If a manufacturer/vendor indicates particular FunctionClasses they shall be im-
 288 plemented and behave in the specified manner
- 289 • Each Smart Sensor shall provide its manufacturer/vendor specific Device description file
 290 (IODD). There shall be no "Profile-IODDs".
- 291 • The Smart Sensor profile does not focus on particular measurement technologies such as
 292 pressure, temperature, and alike. It focuses on common technology-independent features.
- 293 • The Device model shall describe the switching behavior of the Smart Sensor ("Switching
 294 model")
- 295 • Representation and transmission of the measurement information shall be based on Proc-
 296 essDataVariables (PDV) and BinaryDataChannels (BDC)
- 297 • Necessary parameters for the profile shall be defined, for example setpoints, switching
 298 modes, etc.
- 299 • A uniform profile identification shall be specified (which parameter objects are mandatory)
- 300 • A uniform diagnosis information shall be defined

301

302 6.2 Measurement categories for Smart Sensors

303 The Smart Sensor profile definitions are independent from the physical or chemical quantities
 304 to be measured. Table 4 contains a list of typical physical and chemical measurement quanti-
 305 ties for Smart Sensors. The list is far from being complete.

306 **Table 4 – Typical physical and chemical measurement quantities**

Geometry	Movement	Force	Heat	Optic	Chemistry
Position Distance Angle Direction Strain Level	Travel Speed Rotation Displacement Acceleration Vibration	Force Pressure Tension Torque Acceleration	Temperature Heat Heat conductivity Specific heat	Refractivity Irradiance Light density Luminance Chrominance	Substances Volume fraction Mass fraction Humidity Conductivity pH value

307

308 Smart Sensors are independent from the measurement quantities and represent the meas-
 309 urement results in a uniform manner

- 310 • as ProcessDataVariables (PDV) and/or
- 311 • switch information as BinaryDataChannels (BDC)

312 6.3 Smart Sensor model

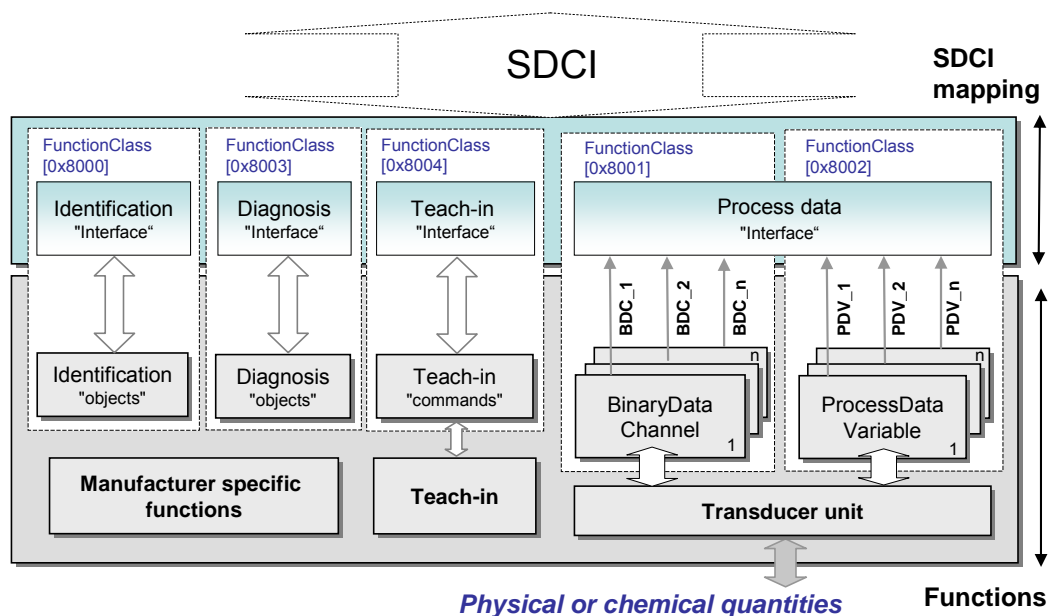
313 The Smart Sensor profile defines a so-called function-driven Device model instead of for ex-
 314 ample an architectural model. That means it only defines independent and consistent func-
 315 tions (FunctionClasses). This allows the manufacturers/vendors to create a large variety of
 316 subsets from basic switching sensors using only the BinaryDataChannel (BDC) up to complex
 317 sensors with several measurement values using the ProcessDataVariables (PDV).

318 A Smart Sensor Device shall only support the indicated profiles and FunctionClasses.

319 Each and every FunctionClass consists of a communication dependent function and an asso-
 320 ciated mapping on the SDCI communication. FunctionClasses are represented and referenced
 321 by profile identifiers, for example FunctionClassID = 0x8001, as shown in Figure 5.

322 The measurement technology (transducer) is manufacturer/vendor specific and not part of this
 323 profile.

324 Figure 5 shows the FunctionClasses defined by the Smart Sensor profile.



325

326

Figure 5 – Overview of FunctionClasses

327 The *Device Identification* (FunctionClass [0x8000]) extends the standard SDCI Device identi-
 328 fication by some additional identification objects. This FunctionClass is mandatory for the
 329 Smart Sensor profile.

330 The *BinaryDataChannel* (FunctionClass [0x8001]) uses the measurement values out of the
 331 transducer unit and creates binary information (BDC_n), whenever certain thresholds are
 332 passed. These thresholds are defined via parameters as defined in clause 9.

333 The *ProcessDataVariables* (FunctionClass [0x8002]) uses the measurement values out of the
 334 transducer unit and creates data structures (PDV_n) representing the physical or chemical
 335 quantity, for example pressure or temperature. These data structures within the Process-
 336 DataVariables are standardized to a maximum extent as shown in clause 10.

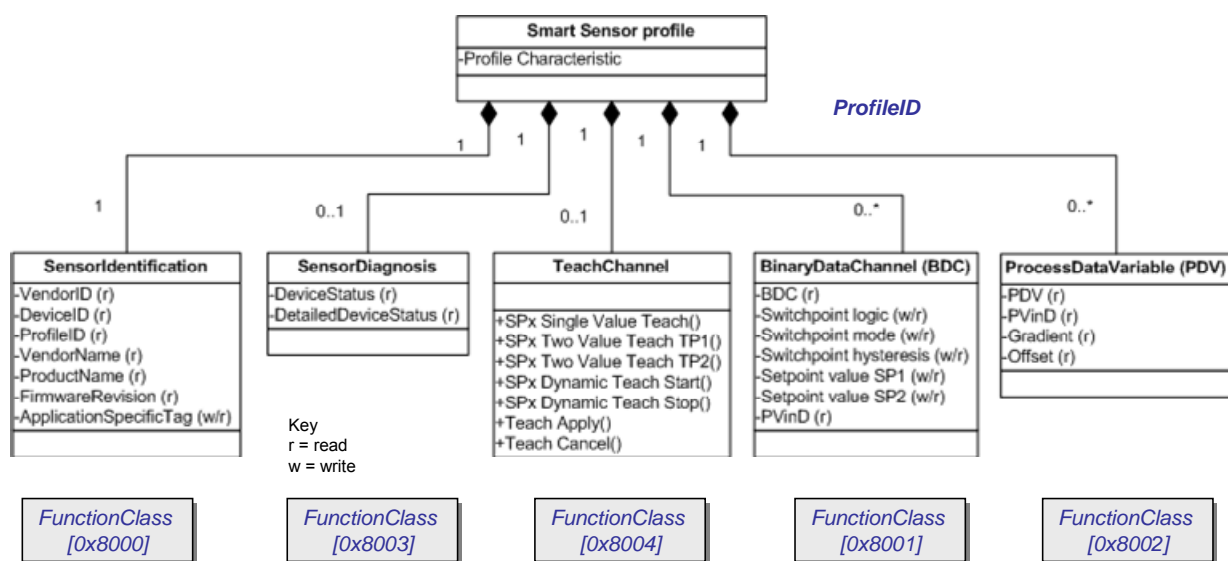
337 The *Device Diagnosis* (FunctionClass [0x8003]) extends the standard SDCI Device diagnosis
 338 by some additional diagnosis objects. This FunctionClass is optional for the Smart Sensor
 339 profile.

340 The *Teach-in Commands* (FunctionClass [0x8004]) allow the user to remotely teach certain
 341 threshold levels in the automation process via the user program in a controller. Manufac-
 342 turer/vendor specific teach-in procedure specialties are not within the scope of this profile.

343 The mapping of BDCs and PDVs into SDCI communication messages is specified in clause 7.
 344 These data structures are designed for simplicity and highest efficiency.

345 **6.4 Smart Sensor object model**

346 The profile for Smart Sensors provides standardized functions that are encapsulated within
 347 Smart Sensor objects. Figure 6 shows the defined FunctionClasses of this Smart Sensor pro-
 348 file. Besides the classes for identification, and diagnosis, it contains the classes Process-
 349 DataVariable and BinaryDataChannel. These classes are showing the associated attributes,
 350 whereas the class TeachChannel shows its defined methods (commands).

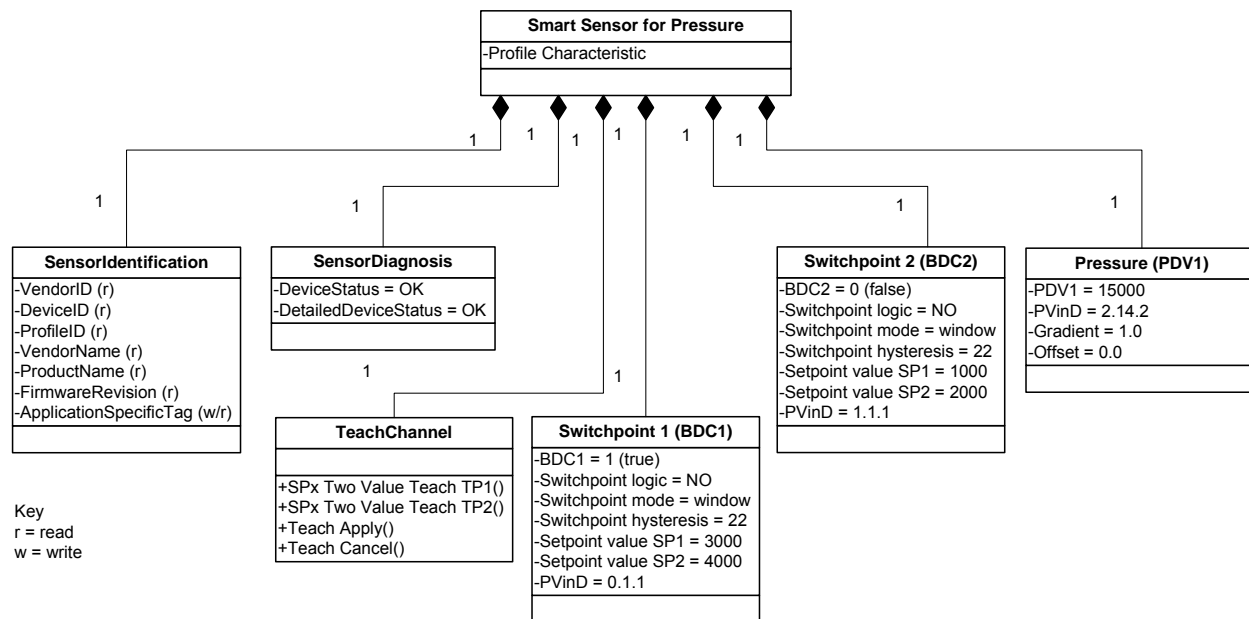


351

352 **Figure 6 – Smart Sensor object model**

353 The classes BDC and PDV can be instantiated 0 to * (n) times as shown in the example in
 354 Figure 7, depending on the complexity of the sensor. The FunctionClass for identification is
 355 mandatory. The FunctionClass for diagnosis is optional.

356



357

358

Figure 7 – Example for a pressure sensor

359 The example sensor in Figure 7 demonstrates:

- 360 • Each BinaryDataChannel (binary output) is represented by its own instance of the class
361 (object) with the instantiated attributes. In the particular example two BDC instances
362 "Switchpoint 1" and "Switchpoint 2" are available.
- 363 • Each measurement value in the "ProcessDataVariable is represented by its own instance
364 of the class (object) with the instantiated attributes. In the particular example one PDV in-
365 stance "Pressure" is available.
- 366 • The TeachChannel offers four commands for remote teach-in (clause 12):
367 - SPx Two Value Teach TP1
368 - SPx Two Value Teach TP2
369 - Teach Apply
370 - Teach Cancel

371 A user program ("client") for example in a PLC can access the BDC and PDV objects via cor-
372 responding functions or methods respectively (Table 5).

373 **Table 5 – Abstract notation for BDC and PDV access of a PLC client**

Read/Write access	Description
Read Sensor1.Pressure.PDV1	Readout of the pressure value with corresponding scale: PDiD, gradient, offset
Read Sensor1.switch point 1.BDC1	Readout of the switching signal state: PDiD
Write Sensor1.switch point 1.SetPointValue SP1	Write SetPointValueSP1

374

375 The parameter set of a FunctionClass can be classified into two groups:

- 376 • Operating parameters, which can be modified during production
- 377 • Configuration parameters (static data), which are only set/modified during commissioning

378

379 **6.5 How to use the Smart Sensor profile**

380 The different FunctionClasses are either mandatory or optional depending on the sensor type.
381 Table 6 shows the possible FunctionClass combinations for different sensor types.

382

Table 6 – FunctionClass combinations for different sensor types

Smart Sensor type	Identification FunctionClass [0x8000]	BDC FunctionClass [0x8001]	PDV FunctionClass [0x8002]	Diagnosis FunctionClass [0x8003]	Teach-in FunctionClass [0x8004]
"Binary" sensor	M	1 to n	-	O	O
"Analog" sensor	M	-	1 to n	O	O
"Binary + analog" sensor	M	1 to n	1 to n	O	O
Key M = mandatory O = optional - = not relevant					

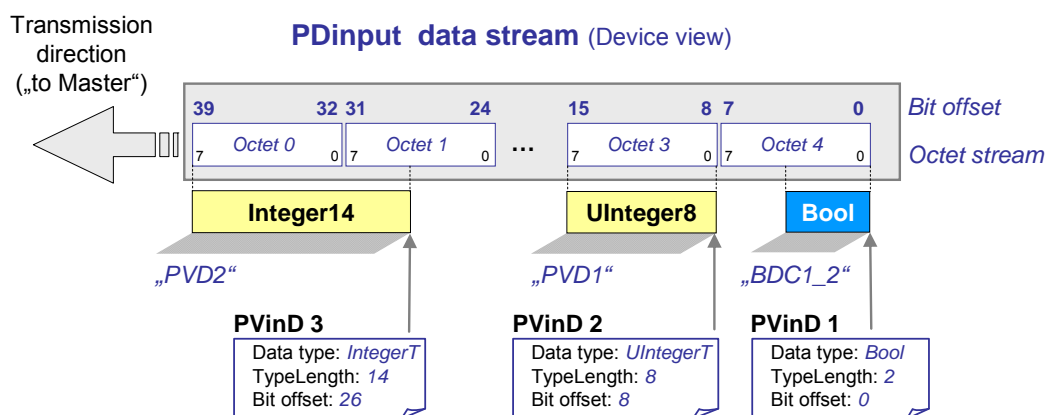
383

384 **7 Process Data mapping (PD)**

385 **7.1 Process Data and its transmission**

386 Depending on the particular type, a Smart Sensor arranges binary information (BDC) and/or 0
 387 to n ProcessDataVariables (PDV) for the cyclic transmission to the Master via SDCI in a so-
 388 called "PInput data stream".

389 Each and every Smart Sensor provides an input Process Data description (PInputDescriptor)
 390 indicating the composition (mapping) of the BinaryDataChannels (BDC) and ProcessData-
 391 Variables (PDV) in the "PInput data stream" with the necessary number of octets.



392

393 **Figure 8 – Example PInput data stream**

394 The "PInput data stream" example shown in Figure 8 comprises 5 octets (octet 0, 1, 2, 3, 4)
 395 to be transmitted to the Master. The Smart Sensor technology (application) maps BDCs and
 396 PDVs into the data stream. The location of each of these data elements within the data
 397 stream is described in a process variable descriptor (PInD). Basis for this description is the
 398 "Bit offset" reaching from the last transmitted bit to the first one as defined in Annex E "Data
 399 types" in [1].

400 NOTE From the user program perspective, usage of standard data types such as UInteger16, or Integer16 would
 401 be the preferred way of mapping. However, due to performance reasons "packed" data structures cannot be
 402 avoided.

403 For Smart Sensors the following information is relevant and it will be specified in the subse-
 404 quent clauses:

- 405 • The content of the PInD process variable descriptor defining the data type and location
 406 of BDC and PDV within the data stream
- 407 • The content of the PInputDescriptor describing "what" is to be transmitted and "how"

408

409 **7.2 Process variable descriptors (PVinD, PVoutD)**410 **7.2.1 Coding**

411 The content of the process variable descriptors PVinD or PVoutD shall be available

- 412 • in the user manual of the Smart Sensor,
- 413 • in the IODD Device description file, and
- 414 • within the Device in the corresponding Index.

415 Each and every PVD or BDC respectively is described unambiguously via its descriptor
 416 PVinD. Subsequent Boolean variables can be described within one PVinD. The following in-
 417 formation shall be provided within a PVinD:

- 418 • the data type (DataType) of the particular process variable. "Set of BoolT" describes here
 419 combined BinaryDataChannels (BDCs)
- 420 • the length of the data type (TypeLength) in bit, for example 6 for UInteger6
- 421 • the bit offset (Bit offset) as the beginning of the variable in the data stream
- 422 • any manufacturer/vendor specific data structures, which cannot be described via the stan-
 423 dard BDC or PDV descriptors, are described via a process variable descriptor (e.g. addi-
 424 tional output data)

425 Table 7 presents the coding of the process variable descriptors PVinD or PVoutD.

426

Table 7 – Coding of PVinD or PVoutD

Bit	Item	Coding
Octet 1	DataType	0: OctetStringT 1: Set of BoolT 2: UIntegerT 3: IntegerT 4: Float32T 5 to 255: reserved
Octet 2	TypeLength	0 to 255 Bit
Octet 3	Bit offset	0 to 255 Bit

427

428 NOTE The abstract notation in this profile specification of a PVinD is: DataType.TypeLength.Bit_offset

429 **7.2.2 PDInputDescriptor**

430 Smart Sensor Devices shall use the standard Device parameter "PDInputDescriptor" in Index
 431 0x000E to store the description information according to Table B.7 in [1]. The user program
 432 within a controller (e.g. PLC) can thus read this information. The "PDInputDescriptor" contains
 433 a descriptor (PVinD) for each and every process variable. Exception: Subsequent Boolean
 434 variables can be described within one PVinD. Table 8 presents an example "PDInputDescrip-
 435 tor" with two PDVs and two combined BDCs.

436

Table 8 – Example "PDInputDescriptor"

Index (dec)	Subindex (dec)	Access	PDInputDescriptor	Coding	Data type
0x000E (14)	1	R	PVinD (BDC1,BDC2)	See Table 7	OctetStringT3
	2	R	PVinD (PDV1)		
	3	R	PVinD (PDV2)		

437

438

439 **7.3 Profile specific PD structures**

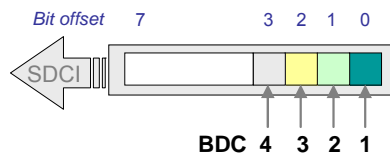
440 **7.3.1 General**

441 In order to avoid a large variety of data structures and descriptors and as a consequence
 442 complexity, this profile specification specifies and recommends only a few variable descrip-
 443 tions.

444 **7.3.2 One or more BDCs (recommended)**

445 It is highly recommended for pure binary Smart Sensors without additional PDVs to use the
 446 data structure demonstrated in Figure 9. The number of supported BDCs, four in Figure 9,
 447 defines the size of the bit field. The BDCs are right-aligned in ascending order without gaps.

448 The PViND in this case is: Set of BoolT.4.0



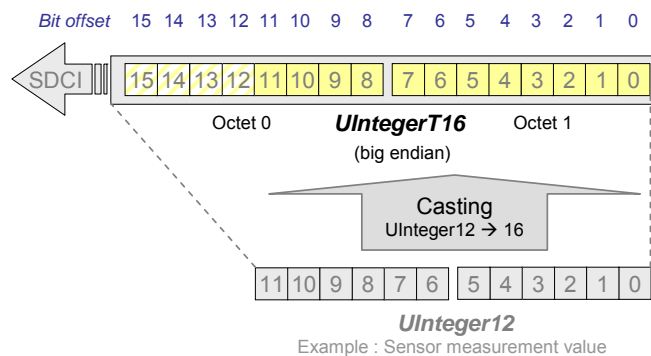
449

450 **Figure 9 – Recommended data structure for pure BDCs**

451 **7.3.3 One PDV**

452 It is highly recommended for Smart Sensors with one PDV to use the data structure demon-
 453 strated in Figure 10. The example shows, that a Smart Sensor can cast an 8, 10, or 14 bit
 454 value into a UIntegerT16 data type, thereby using only part of the space. The leading bits
 455 shall be "0". Variables of type Integer < 16 bit shall also be casted into variables of type Inte-
 456 gerT16. Type casting rules are specified in [1], Annex E2.3 or E2.4.

457 The PViND in this case is: UIntegerT.16.0



458

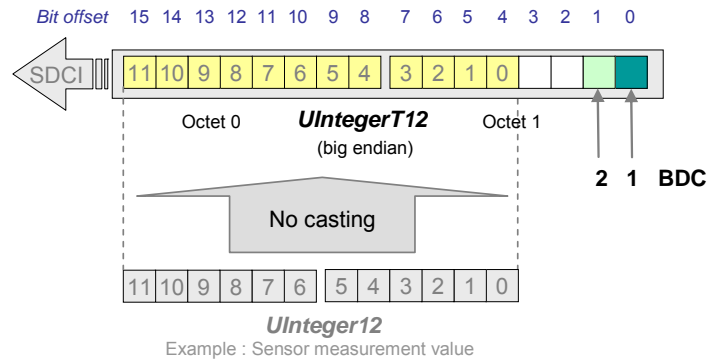
459 **Figure 10 – Recommended data structure for one PDV**

460 **7.3.4 PD lengths up to two octets**

461 Exceptions exist for PD lengths up to two octets. Especially for bit offsets up to 16 other than
 462 octet aligned data types may be used ("packed format"). For PD with more than two octets the
 463 rules in 7.3.5 apply.

464 **7.3.4.1 One PDV and several BDCs**

465 It is highly recommended for Smart Sensors with one PDV and one to two BDCs to use the
 466 data structure demonstrated in Figure 11.



467

468 **Figure 11 – Recommended data structure for a PDV and up to two BDCs**

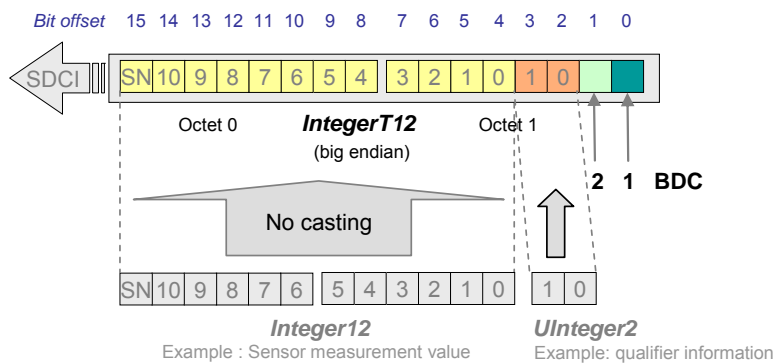
469 The following rules apply:

- 470 • BDCs are right-aligned in ascending order (always at bit offset 0)
- 471 PVinD in this case is: Set of BoolT.2.0
- 472 • PDV with e.g. UIntegerT12 is left-aligned mapped to bit offset 4
- 473 PVinD in this case is: UIntegerT.12.4

474

475 **7.3.4.2 One PDV, several BDCs, and auxiliary variables**

476 It is highly recommended for Smart Sensors with one PDV, one to two BDCs, and auxiliary
 477 variables such as qualifiers to use the data structure demonstrated in Figure 12.



478

479 **Figure 12 – Recommended data structure for a PDV, BDCs, and auxiliary variables**

480

481 The following rules apply:

- 482 • BDCs are right-aligned in ascending order (always at bit offset 0)
- 483 PVinD in this case is: Set of BoolT.2.0
- 484 • PDV with IntegerT12 (e.g. measurement value) is mapped left-aligned to bit offset 4
- 485 PVinD in this case is: IntegerT.12.4
- 486 • Auxiliary variables (e.g. qualifier information) shall be right-aligned to the BDCs
- 487 PVinD in this case is: UIntegerT.2.2

488

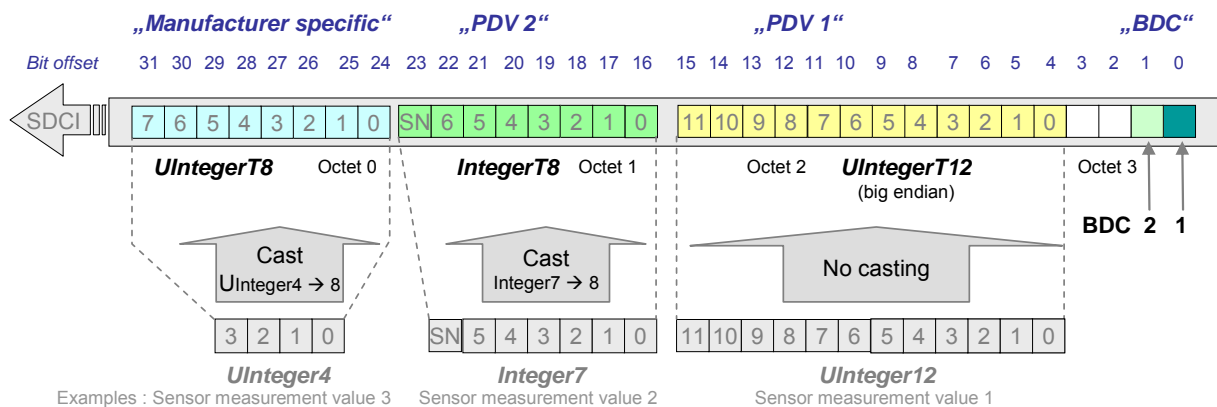
489 **7.3.5 PD lengths larger than two octets**

490 It is highly recommended for Smart Sensors with 0 or more BDCs, 2 or more PDVs, and
 491 manufacturer/vendor specific process data (outside the scope of this profile specification) to
 492 use the data structure demonstrated in the example in Figure 13. The following rules shall be
 493 observed (mandatory):

- 494 • Within the first two octets the rules of 7.3.4 apply. Especially the BDCs are always starting
495 at bit offset 0.
- 496 • All variables starting at bit offset 16 shall be mapped octet aligned. Potential waste of bits
497 is accepted. Variables shall be casted to SDCI data structures if necessary. See [1], An-
498 nex E2.3 and E2.4 for casting rules.

499 In addition, it is highly recommended to observe the following rules (recommended):

- 500 • Best practice for PDVs is the usage of UInteger16 or Integer16 respectively (easier data
501 processing)
- 502 • UIntegerT to be favored over IntegerT
- 503 • Manufacturer/vendor specific process data can use their own rules. However, it is highly
504 recommended to observe the rules within this profile



505

506 **Figure 13 – Recommended data structure for multi PDVs and zero or more BDCs**

- 507 The PViDs in Figure 13 are:
- 508 PViD 1 Set of BoolT.2.0 (BDC2 and BDC1)
 - 509 PViD 2 UInteger.12.4 (PDV1)
 - 510 PViD 3 Integer.8.16 (PDV2)
 - 511 PViD 4 UInteger.8.24 (Manufacturer/vendor specific)

512

513 8 Device identification objects [0x8000]

514 Table 9 shows the deviating definitions in this profile as opposed to the standard [1].

515 **Table 9 – Deviating definitions for identification data objects**

Index (dec)	Object name	Access	Length (octets)	Data Type	Mandatory/Optional	Comment
0x0013 (19)	Product_ID	R	Max. 64	StringT	M	Herein mandatory
0x0017 (23)	Firmware Revision	R	Max. 64	StringT	M	Herein mandatory
0x0018 (24)	ApplicationSpecificTag	R/W	Min. 16, max. 32	StringT	M	Herein mandatory
Keys R = read W = write						

516

517

518 **9 BinaryDataChannel [0x8001]**

519 **9.1 Characteristic of the BDC**

520 This FunctionClass represents as process data the binary switching state information (BDC).
521 It requires configuration and parameterization.

522 **9.2 Configuration and parameterization of the BDC**

523 **9.2.1 General**

524 This profile specification defines several best-practices BDCs. Manufacturer/vendor specific
525 BDCs are always possible.

526 The following 4 parameters define the switching behavior of a BDC:

- 527 • Switchpoint logic
- 528 • Switchpoint hysteresis
- 529 • Switchpoint mode
- 530 • Setpoints SP1 and SP2

531 The parameters are specified in the subsequent clauses.

532 The Setpoint parameters are defined in detail in 9.2.5. The coding of the Setpoint and Switch-
533 point parameters is specified in 9.2.6.

534 **9.2.2 Switchpoint logic**

535 The parameter "Switchpoint logic" defines whether the switching information is transmitted in
536 inverted or not inverted manner.

537 **9.2.3 Switchpoint hysteresis**

538 The parameter "Switchpoint hysteresis" defines whether a hysteresis is associated with the
539 Setpoints SP1 and SP2. The layout of the hysteresis in respect to SP1 and SP2, for example
540 symmetrical, right-aligned, or left-aligned, etc. is manufacturer/vendor specific. It cannot be
541 defined in the FunctionClass.

542 The interpretation of the hysteresis values (relative or absolute) is also manufacturer/vendor
543 specific.

544 **9.2.4 Switchpoint mode**

545 **9.2.4.1 Overview**

546 The parameter "Switchpoint mode" defines how the binary switching information is created
547 depending on Setpoint parameters (SP1, SP2) and the current measurement value.

548 The Switchpoint Mode does not define the switching function itself. The different sensor types
549 are using different switching functions depending on the various manufacturer/vendor specific
550 applications.

551 The quiescent state of sensors for presence detection (e.g. optical proximity sensors or ultra-
552 sonic sensors) is a measurement value of "infinite". An approaching object will cause the
553 switching information of the sensor to change at the setpoint (measurement value). The de-
554 parting object will cause the switching information of the sensor to switch back at a larger
555 measurement value than the setpoint (see Figure 14)

556 The quiescent state of sensors for quantity detection (e.g. pressure or temperature sensors)
 557 is a measurement value of "zero". An increasing measurement value will cause the switching
 558 information of the sensor to change at the setpoint. A decreasing measurement value will
 559 cause the switching information of the sensor to switch back at a smaller measurement value
 560 than the setpoint (see Figure 15).

561 The associated FunctionClass comprises 4 different modes:

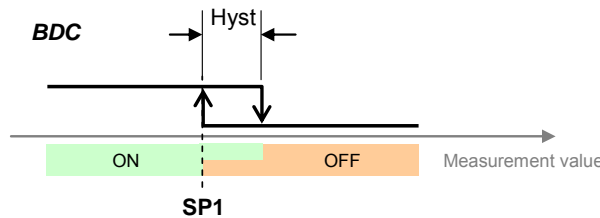
- 562 • Deactivated
- 563 • Single Point Mode
- 564 • Window Mode
- 565 • Two Point Mode

566 If a Smart Sensor implements a BDC, it shall support at least one of these Switchpoint modes.
 567 Additional modes are optional. In case a Smart Sensor does not support any other of the ad-
 568 ditional optional modes, the general rule for not supported parameters applies (9.3.3). It is
 569 possible for a manufacturer/vendor to supplement the above defined modes by his own spe-
 570 cific modes.

571 **9.2.4.2 Single Point Mode**

572 Figure 14 demonstrates the switching behavior in Single Point Mode. The switching informa-
 573 tion changes, when the current measurement value passes the threshold defined in Setpoint
 574 SP1. This change occurs with raising or falling measurement values. If a hysteresis is defined
 575 for SP1, the switching behavior shall observe the hysteresis as shown in Figure 14. This be-
 576 havior is typical for "presence detection of objects" with none symmetrical hysteresis in re-
 577 spect to SP1 and not inverted switching.

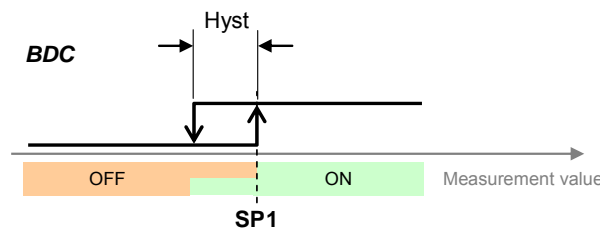
578 The Setpoint SP2 is not relevant for this mode.



579

580 **Figure 14 – Example of a Single Point Mode for presence detection**

581 The behavior shown in Figure 15 is typical for "quantity (level) detection of materials (liquids)"
 582 with none symmetrical hysteresis in respect to SP1 and not inverted switching.



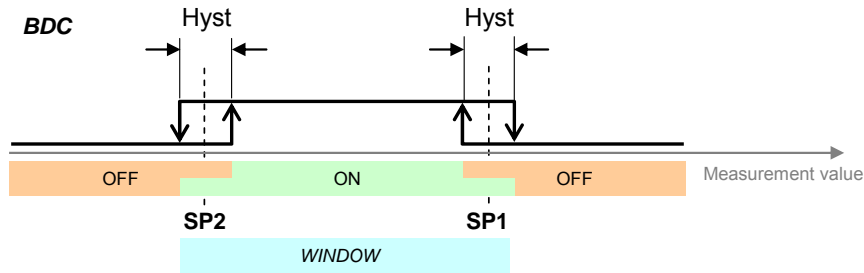
583

584 **Figure 15 – Example of a Single Point Mode for quantity detection**

585 **9.2.4.3 Window Mode**

586 Figure 16 demonstrates the switching behavior in Window Mode. The switching information
 587 changes, when the current measurement value passes the thresholds defined in Setpoint SP1
 588 and Setpoint SP2. This change occurs with raising or falling measurement values.

589 If hysteresis is defined for SP1 and SP2, the switching behavior shall observe the hysteresis
 590 as shown in Figure 16. This behavior shows symmetrical hysteresis in respect to SP1 and
 591 SP2 and not inverted switching.



592

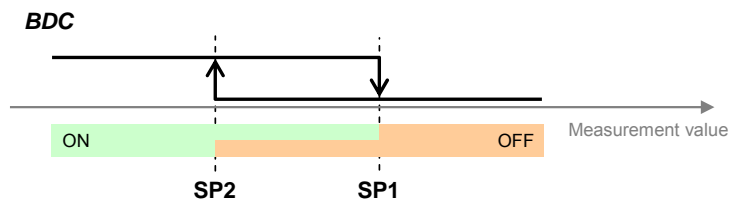
593 **Figure 16 – Example for the Window Mode**

594 **9.2.4.4 Two Point Mode (without hysteresis)**

595 Figure 17 demonstrates the switching behavior in Two Point Mode. The switching information
 596 changes, when the current measurement value passes the threshold defined in Setpoint SP1.
 597 This change occurs only with raising measurement values. The switching information changes
 598 also, when the current measurement value passes the threshold defined in Setpoint SP2. This
 599 change occurs only with falling measurement values. Hysteresis shall be ignored in this case.

600 If the measurement value is in between SP1 and SP2 at power-on of the Smart Sensor, the
 601 behavior depends on the manufacturer/vendor specific design of the Device.

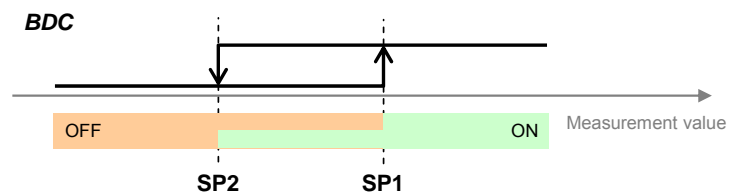
602 The behavior shown in Figure 17 is typical for "presence detection of objects" with no hys-
 603 teresis in respect to SP1 and SP2 and not inverted switching.



604

605 **Figure 17 – Example for the Two Point Mode of presence detection**

606 The behavior shown in Figure 18 is typical for "quantity (level) detection of materials (liquids)"
 607 with no hysteresis in respect to SP1 and SP2 and not inverted switching.



608

609 **Figure 18 – Example for the Two Point Mode of quantity detection**

610 **9.2.5 Setpoint parameters (SP1, SP2)**

611 A Smart Sensor deploys at least the Setpoint SP1 or both Setpoints SP1 and SP2 per BDC.
 612 However, it always shall provide both Setpoint parameters of this FunctionClass BDC. That
 613 means, even if the Smart Sensor does not use SP2 in its switching functions, it shall support
 614 read and write access to both parameters. In case a Smart Sensor does not support any pa-
 615 rameters, the general rule for not supported parameters applies (see 9.3.3).

616 The interpretation of the Setpoints SP1 and SP2 depends on the implementation of the manu-
 617 facturer/vendor. However, if the measurement value for the definition of switching information
 618 (BDC) is also provided as a ProcessDataVariable (PDV), the Setpoints shall be represented in
 619 the same manner, for example with Gradient and Offset and octet granular data types (≥ 1
 620 octets). See 10.2 for details.

621 The Smart Sensor Device shall support all the necessary plausibility checks described in
 622 clause 10 ("Device") of the standard [1] and the following:

- 623 • Setpoint SP2 shall be outside the hysteresis range of SP1
- 624 • Setpoints SP1 and SP2 are within the measurement value range

625

626 In case one or more checks failed, the Smart Sensor shall behave in the following manner:

- 627 • During acyclic data exchange (via ISDU), the Device shall return a negative response and
 628 restore the previous values
- 629 • During cyclic data exchange, the Device shall send valid Process Data based on previous
 630 valid parameter data

631

632 In order to avoid inconsistent configuration data it is important to note,

- 633 • that SP1 and SP2 data are written together via Subindex 0 (one record) guaranteeing that
 634 a changed value of SP1 or SP2 cannot cause a plausibility check error, or
- 635 • that the option Block Parameter [1] is used for a change of configuration guaranteeing a
 636 plausibility check and activation of the written parameters not before the termination of the
 637 entire transmission.

638

639 **9.2.6 Setpoint and Switchpoint parameter coding**

640 Table 10 shows the parameter coding of the Setpoint and Switchpoint parameters.

641 **Table 10 – Setpoint and Switchpoint parameter coding**

Object name	Length	Data Type	Coding	Definition
Setpoint SP1/2	8/16/32/64	UIntegerT IntegerT Float32T	Manufacturer/vendor specific	Typically corresponding to the PDV. However, the data structure is extended to octet granular data types and right-aligned.
Switchpoint logic	8	UIntegerT	0x00 : Value as specified Optional values: 0x01 : Inverted value 0x02 ... 0x7F : Reserved 0x80 ... 0xFF : Vendor specific	Binary value of the switching information ("1" = true, "0" = false) within the BDC (Binary-DataChannel)

Object name	Length	Data Type	Coding	Definition
Switchpoint mode	8	UIntegerT	0x00 : Deactivated 0x01 : Single point mode 0x02 : Window mode 0x03 : Two point mode 0x04 to 0x7F : Reserved 0x80 to 0xFF : Vendor specific	One of the defined modes shall be supported
Switchpoint hysteresis	16	UIntegerT	0x0000 : mandatory, if no hysteresis or vendor specific default Optional values: 0x0001 to 0xFFFF: Vendor specific definition	-

642

643 **9.3 BDC mapping**644 **9.3.1 Concepts**

645 The binary switching information of the BDCs is mapped into the PDinput data stream (Figure
646 8) as defined in 7.3. The configuration and the parameterization of the BDCs are mapped in
647 the profile related Index space as illustrated in Table 1.

648 The BDC FunctionClass [0x8001] can be parameterized via the standardized parameter ob-
649 jects described within the subsequent clause.

650 **9.3.2 BDC Index space**

651 Each and every BDC features a parameter set to define its switching behavior (Switchpoints)
652 and an additional parameter set to define the thresholds (Setpoints). The mapping of these
653 parameter sets for BDC1 and BDC 2 is shown in Table 11. The coding of the parameters is
654 defined in Table 10.

655

Table 11 – Index space for BDC1 and BDC2

Index (dec)	Subindex (dec)	Access	Parameter name	Coding	Data type	Comment
0x003C (60)	01	R/W	Setpoint SP1	See Table 10	UIntegerT IntegerT Float32T	BDC1
	02	R/W	Setpoint SP2		UIntegerT IntegerT Float32T	
0x003D (61)	01	R/W	Switchpoint logic		UIntegerT	
	02	R/W	Switchpoint mode		UIntegerT	
	03	R/W	Switchpoint hysteresis		UIntegerT	
0x003E (62)	01	R/W	Setpoint SP1		UIntegerT IntegerT Float32T	BDC2
	02	R/W	Setpoint SP2		UIntegerT IntegerT Float32T	
0x003F (63)	01	R/W	Switchpoint logic		UIntegerT	
	02	R/W	Switchpoint mode		UIntegerT	
	03	R/W	Switchpoint hysteresis	UIntegerT		

656

657 Index space for additional 126 BDCs is available in the ProfileSpecificIndex space (Table 1).
658 Thus, BDC3 is located in 0x4000 and 0x4001 and BDC128 in 0x407B and 0x407C.

659 9.3.3 Access behavior of not supported Subindices

660 The parameters for each and every supported BDC shall be readable and writeable as already
661 indicated in Table 11. In detail the following rules apply:

- 662 • Parameters of a BDC not functionally supported by the Smart Sensor shall also be read-
663 able and writeable
- 664 • Those parameters can be written with the default value
- 665 • If other than default values are written, the Smart Sensor shall respond with the ErrorCode
666 0x8030 (PAR_VALOUTOFRNG = parameter value out of range)
- 667 • In case of a readout of a functionally not supported parameter, the Smart Sensor shall re-
668 spond with the default value
- 669 • In case of access to not supported BDCs, the Smart Sensor shall respond with the Error-
670 Code 0x8011 (IDX_NOTAVAIL = Index not available)

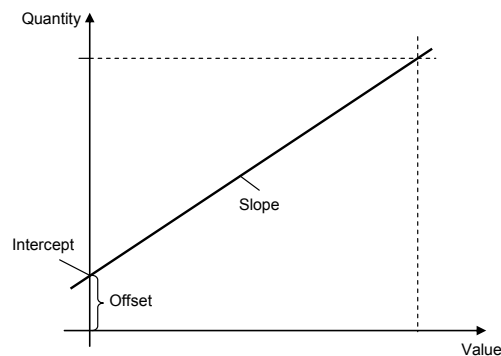
671

672 10 ProcessDataVariable [0x8002]

673 10.1 Scaling and dimensions

674 Normally, the ProcessDataVariable of a Smart Sensor carries a measurement value of a
675 physical or chemical quantity within the data structures (PDV) defined by the manufac-
676 turer/vendor of the Device. See clause 7 for details.

677 The transmitted value can be converted into a dimensioned value (°F, °C, inch, m, etc.) via a
678 linear equation $y = m \cdot x + b$. "m" represents the slope and "b" the intercept with the y coordi-
679 nate. Within this profile, "slope" is called "gradient" and the value of the intercept is called
680 "Offset". Figure 19 illustrates the relationships.



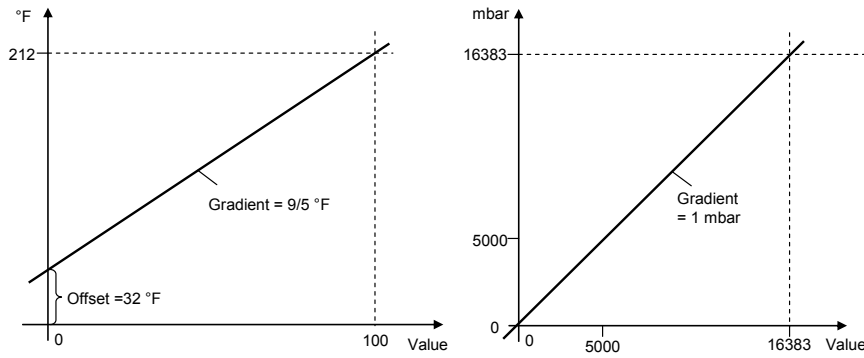
681

682 **Figure 19 – Value to quantity conversion via linear equation**

683 The manufacturer/vendor is responsible for the provision of the "Gradient" and the "Offset"
684 values for the conversion equation (1).

$$\text{Variable} = \text{Gradient} \times \text{PDV} + \text{Offset} \quad (1)$$

685 Usually the data type for Gradient and Offset is Float32T. With the help of this information any
686 computer software or PLC can calculate the dimensioned variable out of the transmitted PDV.
687 Figure 20 illustrates two conversion examples for pressure and temperature.



688

689

Figure 20 – Conversion examples

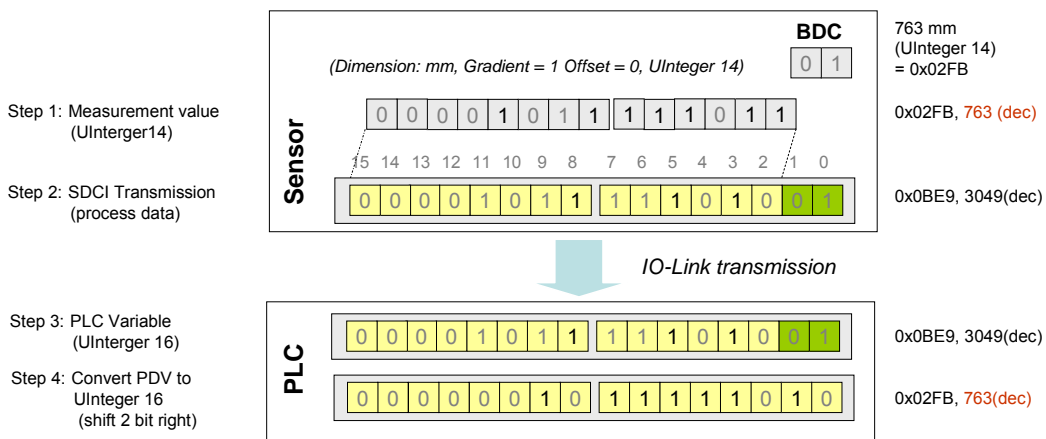
690 Usually, the transmitted PDV value is based on a dimensioned measurement value as shown
 691 in the right example of Figure 20 (pressure in mbar). In the left example a dimensioned tem-
 692 perature measurement value (°C) is converted in °F.

693 **10.2 Recommended PDV representation**

694 Objective of the recommendations within this clause is to demonstrate the data processing of
 695 PDVs in PLCs. It is highly recommended to observe the following rules in order to simplify the
 696 programming and to increase performance:

- 697 • PDVs of size > 16 bit should be represented in octet granular data types (16, 24, 32),
 698 preferably UIntegerT
- 699 • For data < 16 bit the data type UIntegerT should be used that is easily extendable to octet
 700 granular data types
- 701 • Preferred data lengths are 8, 12, 14, 16, 32, or 64 bit
- 702 • PDVs should carry dimensioned measurement values as shown in Figure 20 and Figure
 703 21

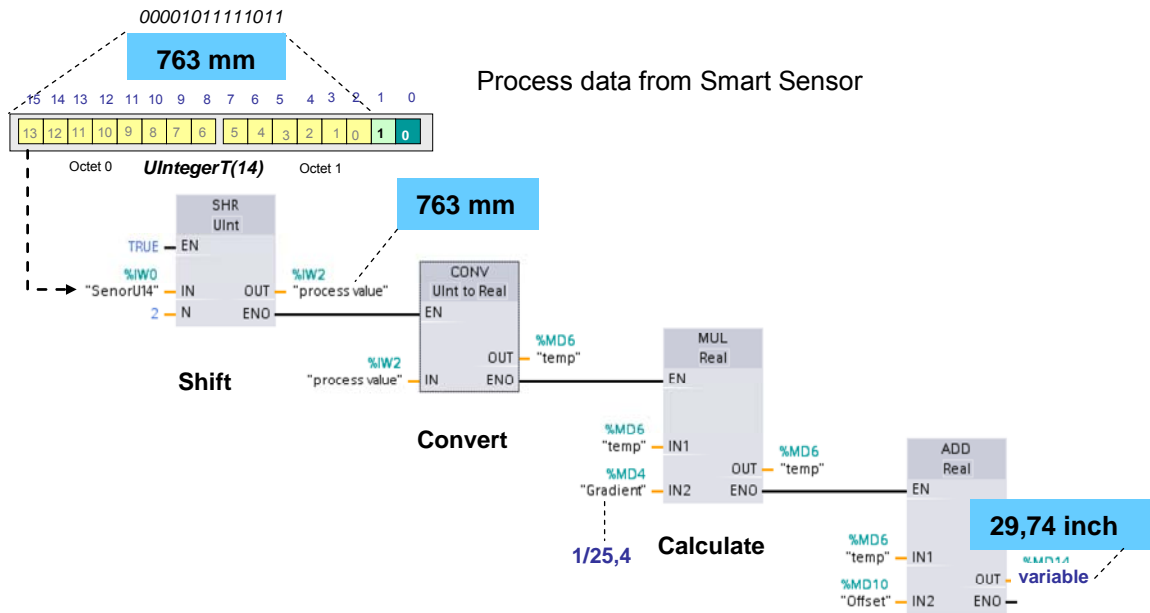
704 Figure 21 illustrates the relationship between a dimensioned PDV and its PLC variable.



705

706 **Figure 21 – Relationship between a dimensioned PDV and its PLC variable**

707 Figure 22 demonstrates a typical PLC user program for a measurement value conversion. A
 708 PLC user program transforms the PDV via shift operations into a 16 bit UInteger variable.



709

710

Figure 22 – Example PLC program for a measurement value conversion

711

712 **11 Diagnosis [0x8003]**

713 **11.1 DeviceStatus and DetailedDeviceStatus**

714 Each Smart Sensor Device shall feature a hierarchical diagnosis status within the parameter
 715 objects DeviceStatus and DetailedDeviceStatus as shown in Table 1 and defined in [1].

716 The DeviceStatus and DetailedDeviceStatus are already defined in [1] and need no further
 717 profile specific definitions.

718 However, Smart Sensors shall meet the following requirements for DetailedDeviceStatus:

- 719 • Only entries of Events of type "appears"/"disappears"
- 720 • Each appeared Event (Event Qualifier and EventCode) shall be entered
- 721 • Each disappeared Event shall be entered and lead to a deletion of the corresponding entry
 722 (identical EventCode) in DetailedDeviceStatus or to an overwriting with "0". This way, the
 723 current diagnosis status is always represented within the DetailedDeviceStatus.
- 724 • The DetailedDeviceStatus contains a maximum of 64 entries and thus can keep 64 current
 725 diagnosis statements at a time. The actual size is manufacturer/vendor dependent.
- 726 • The DetailedDeviceStatus buffer shall be cleared at each start-up of the Smart Sensor
 727 Device and refilled with diagnosis statements based on faults still in place
- 728 • Implementation hint: The dynamic/static strategy for the entries is manufacturer/vendor
 729 specific:
 - 730 - static: one fixed diagnosis statement within a particular Subindex
 - 731 - dynamic: an occurring diagnosis information will be entered in the next free Subindex
 732 (revolving system)

733 **11.2 Smart Sensor EventCodes**

734 The IEC 61131-9 [1] reserves in Annex D the EventCode range from 0xB000 to 0xBFFF for
 735 profiles. This profile for Smart Sensors does not define any profile specific EventCode.

736 12 TeachChannel [0x8004]

737 12.1 Teach-in concepts for Smart Sensors

738 The FunctionClass "TeachChannel" defines an interface for remote teach-in functions via
739 SDCI communication and standardized commands for the most common basic teach-in
740 mechanisms. Thus, the Smart Sensor profile provides a uniform and flexible interface for sev-
741 eral teach-in methods. Instead of defining all kinds of teach-in methods, this FunctionClass
742 defines a set of universal commands that can be used in various sequences to realize many
743 individual methods. This includes the calculation algorithms for the associated parameters
744 such as the thresholds for the Setpoints SP1 and SP2. The FunctionClass provides a "music
745 instrument"; the "music" to play is defined by the manufacturer/vendor.

746 Two parameters are defined to control the teach-in procedure. The "Teach-in Channel" pa-
747 rameter (12.2 and Table 13) allows to select the BDC to be taught. This is required, if several
748 BDCs are assigned to a teach-in procedure and the adjustment of the threshold values. It is
749 default behavior, that teach-in commands are automatically active for the BDC with teach-in
750 capability defined by the manufacturer/vendor. It is highly recommended for basic Smart Sen-
751 sors to assign teach-in capability to BDC1 in order to avoid explicite addressing of a BDC.

752 Several commands are defined for the second parameter "Teach-in Command" (12.3 and
753 Table 13). Each individual command enables the user to start one out of several standardized
754 teach-in procedures. The commands are described within the context of a possible application
755 within the subsequent clauses.

756 The FunctionClass [0x8004] provides also feedback on the status and the results of the
757 teach-in activities. A universal state machine with common states (Idle, Busy, Wait-on-
758 command, Success, and Error) for the different teach-in procedures is defined in 12.4.2. The
759 parameter "Teach-in Status" holds the information about the current state of the activated
760 teach-in procedure (12.4). The parameter provides two different types of information:

- 761 • Teach Flags: Feedback, whether the Device determined a certain "Teachpoint" success-
762 fully or not
- 763 • Teach State: Feedback on the current state of the particular teach-in procedure

764 12.2 Parameter 1: "Teach-in Channel"

765 The parameter "Teach-in Channel" allows addressing the particular BDC or a set of BDCs for
766 which the teach-in commands apply. A maximum of 128 BDCs can be addressed.

767 12.3 Parameter 2: "Teach-in Command"

768 12.3.1 General

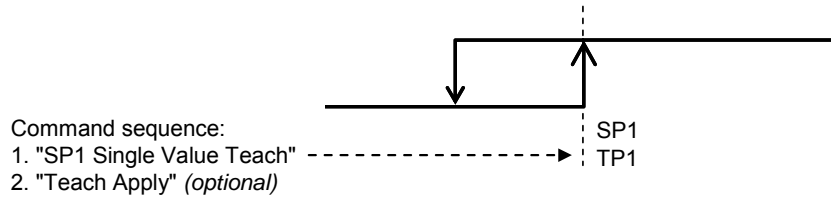
769 The parameter "Teach-in Command" allows teaching of a teachpoint (TP) or controlling of the
770 teach-in procedure. Manufacturer/vendor specific extensions are possible. The commands of
771 the FunctionClass [0x8004] are described within the context of a possible application in the
772 subsequent clauses.

773 12.3.2 "Single Value Teach"

774 A threshold is defined by one "Teachpoint" (TP). The teach-in procedure is "static", which
775 means, the measurement value is constant during the teach-in procedure.

776 The associated commands "0x41" and "0x42" are specified in Table 14.

777 Figure 23 illustrates an example for "Single Value Teach" in "Single Point Mode".



778

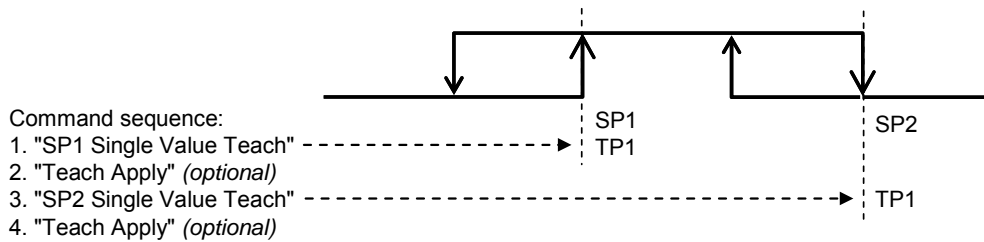
779

Figure 23 – "Single Value Teach" (Single Point Mode)

780

781

Figure 24 illustrates an example for "Single Value Teach" in "Window Mode".



782

783

Figure 24 – "Single Value Teach" (Window Mode)

784

785

12.3.3 "Two Value Teach"

786

A threshold is defined by two "Teachpoints" (TP). The teach-in procedure is "static", which means, the measurement value is constant during the teach-in procedure.

787

788

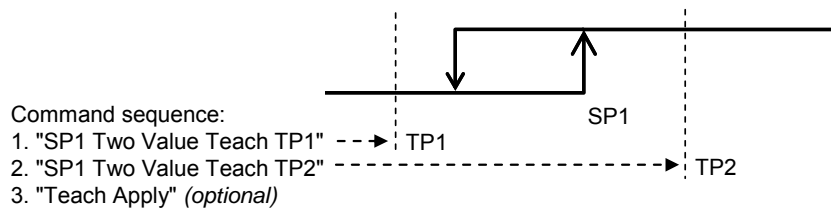
The associated commands "0x43" to "0x46" are specified in Table 14.

789

NOTE The calculation method to determine SP from TP1 and TP2 is manufacturer/vendor specific.

790

Figure 25 illustrates an example for "Two Value Teach" in "Single Point Mode".



791

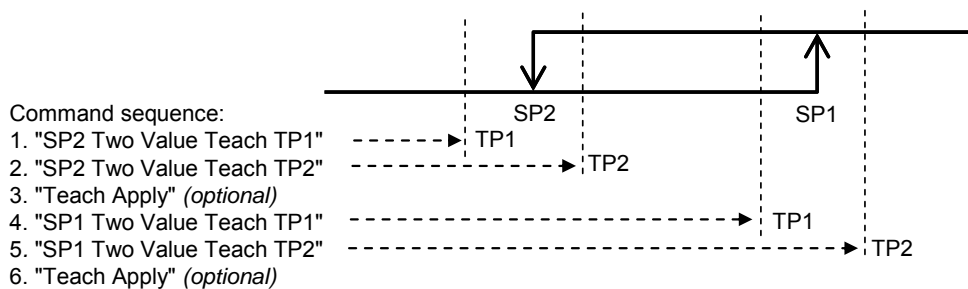
792

Figure 25 – "Two Value Teach" (Single Point Mode)

793

794

Figure 26 illustrates an example for "Two Value Teach" in "Two Point Mode".



795

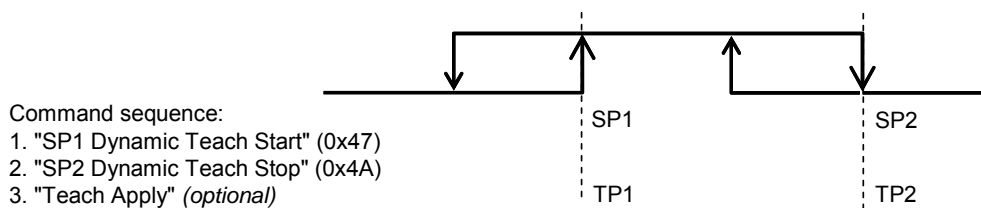
796

Figure 26 – "Two Value Teach" (Two Point Mode)

797 12.3.4 "Dynamic Teach" (within a time period)

798 One single threshold or both thresholds of a BDC are set-up via captured measurement val-
 799 ues during a certain period of time. The teach-in procedure is "dynamic", which means, the
 800 measurement value is not constant during the teach-in procedure. Usually, the minimum and
 801 maximum values within this time frame are taken to define the thresholds. The associated
 802 commands "0x47" to "0x4A" are specified in Table 14 .

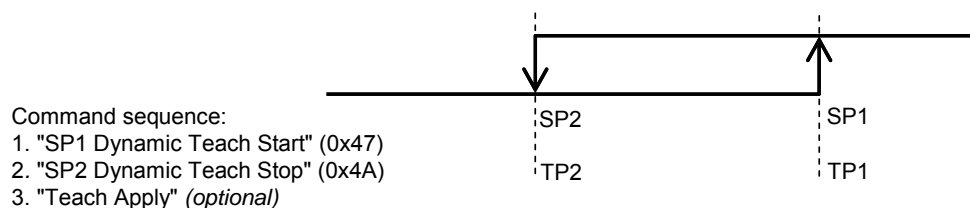
803 Figure 27 illustrates an example for "Dynamic Teach" in "Window Mode", where commands
 804 "0x47" and "0x4A" are used for the determination of both Setpoints SP1 and SP2 (see NOTE
 805 in Table 14). It is the responsibility of the manufacturer to describe the required commands for
 806 the "Dynamic Teach" procedure.



808 **Figure 27 – "Dynamic Teach" (Window Mode)**

809

810 Figure 28 illustrates an example for "Dynamic Teach" in "Two Point Mode", where commands
 811 "0x47" and "0x4A" are used for the determination of both Setpoints SP1 and SP2 (see NOTE
 812 in Table 14).



814 **Figure 28 – "Dynamic Teach" (Two Point Mode)**

815

816 12.3.5 "Teach Apply"

817 The command "Teach Apply" can be used optionally to terminate the teach-in procedure with
 818 the calculation of the thresholds. In this case, the thresholds will be accepted only after
 819 "Teach Apply".

820 12.3.6 "Teach Cancel"

821 The command "Teach Cancel" can be used to cancel the teach-in procedure without calcula-
 822 tion of the thresholds. In this case, the previously taught thresholds will be established.

823

824 12.4 Parameter 3: "Teach-in Status"

825 12.4.1 Status types

826 The parameter "Teach-in Status" provides feedback on the status and the results of the teach-
 827 in activities. This status information is split into "Teach State" and "Teach Flags" (Figure 30).

828 The following "Teach States" are defined:

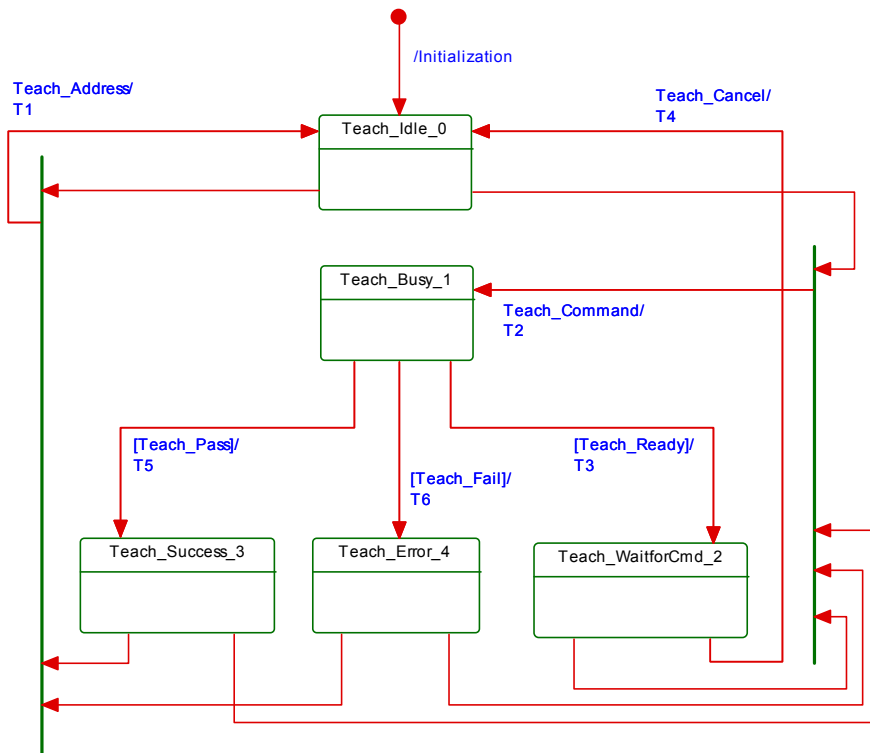
- 829 • IDLE
- 830 • BUSY
- 831 • WAIT FOR COMMAND
- 832 • SPxSUCCESS
- 833 • ERROR

834 See Table 12 for definitions of these status types reported via the "Teach-in Status" parameter, and Table 13 for the mapping of this parameter. The reported status information can be extended manufacturer/vendor specific.

837 In order to differentiate the teach-in status information "Teach Flags" are available, only indicating the result of the Teachpoint (TP) capture (Figure 30 and Table 17).

839 **12.4.2 Teach-in dynamics**

840 Figure 29 shows a state machine for the common teach-in procedure.



841

842 **Figure 29 – State machine of the common teach-in procedure**

843 A taken state depends on the received particular teach-in command. Thus, a reported "Teach-in Status" depends on the actual state of the state machine for the teach-in procedure.

845 Table 12 shows the state transition tables of the teach-in procedure.

846

Table 12 – State transition tables of the teach-in procedure

847

STATE NAME		STATE DESCRIPTION	
Teach_Idle_0		In this state the Device is waiting for a new teach-in channel address or a teach-in command. The Device operates with the initial or last valid Setpoint settings for the selected teach-in channel.	
Teach_Busy_1		In this state the acquisition of Teachpoint values and/or calculation of Setpoint values take place. The state is left on a ready signal of either of these actions. Depending on Device implementation acquisition of Teachpoints and calculation of Setpoints may be executed in one single sequence, without requirement for further teach-in commands.	
Teach_WaitForCmd_2		In this state the Device is waiting for a new teach-in command. The state is left on receiving any valid teach-in command or a teach-in cancel command.	
Teach_Success_3		In this state the Device operates with the newly acquired and calculated Setpoint values for the selected teach-in channel. The state is left on receiving a new teach-in channel address or a teach-in command	
Teach_Error_4		In this state the Device operates with the last valid Setpoint settings for the selected teach-in channel.	
TRANSITION	SOURCE STATE	TARGET STATE	ACTION
T1	0,3,4	0	The teach-in channel address is set to the selected value. The Teach Flags are reset. The reported Teach State is "IDLE".
T2	0,2,3,4	1	The acquisition of a single or several Teachpoints is started for the selected teach-in channel. The reported Teach State is "BUSY".
T3	1	2	The acquisition of a single or several Teachpoints is ready and the Device requires further teach-in commands. The Teach Flags for the acquired Teachpoints are set. The reported Teach State is "WAIT FOR COMMAND".
T4	2	0	Teach Flags are reset. The last valid Setpoint settings are restored. The reported Teach State is "IDLE".
T5	1	3	Teach Flags are reset. The new set point values are activated. The reported Teach State is "SP1SUCCESS", "SP2SUCCESS" or "SP12SUCCESS", depending on the already executed Setpoint calculations since selection of the teach-in channel.
T6	1	4	Teach Flags are reset. The last valid set point values are restored. The reported Teach State is "ERROR".
Initialization	-	0	The teach-in channel address is initialized with the default value. Teach Flags are reset. The reported Teach State is "IDLE".
INTERNAL ITEMS		TYPE	DEFINITION
Teach Flags		-	See Figure 30
Teach State		-	See Figure 30
Teach_Pass		-	Setpoint successfully calculated from Teachpoints
Teach_Fail		-	Teachpoints inconsistent or Setpoint calculation impossible
Teach_Ready		-	A single teach-in action terminated

849

850

851 12.5 Mapping to SDCI communication

852 Table 13 shows, how the "Teach-in Command", the "Teach-in Channel", and "Teach-in
853 Status" parameters are mapped into the SDCI Index space. The SystemCommand parameter
854 is used as a vehicle to convey the "Teach-in Commands". The table references the individual
855 coding tables Table 14, Table 15, Table 16, and Table 17.

856

Table 13 – Teach-in related parameter objects (Index)

Index (dec)	Object name	Access	Length	Data type	Comment
0x0002 (2)	SystemCommand	Write		UIntegerT (8)	See Table 14
0x003A (58)	Teach-In Channel	Read/Write		UIntegerT (8)	See Table 15
0x003B (59)	Teach-In Status	Read		UIntegerT (8)	See Figure 30, Table 16, and Table 17

857

858 Table 14 shows the "Teach-in Command" coding. These commands are transmitted using the
859 SystemCommand parameter.

860

Table 14 – "Teach-in Command" coding

Teach-in Command	Value	Comment
Teach Apply	0x40	Calculate and apply SP1,2 from Teachpoint(s)
SP1 Single Value Teach	0x41	Determine Teachpoint 1 for Setpoint1
SP2 Single Value Teach	0x42	Determine Teachpoint 1 for Setpoint2
SP1 Two Value Teach TP1	0x43	Determine Teachpoint 1 for Setpoint1
SP1 Two Value Teach TP2	0x44	Determine Teachpoint 2 for Setpoint1
SP2 Two Value Teach TP1	0x45	Determine Teachpoint 1 for Setpoint2
SP2 Two Value Teach TP2	0x46	Determine Teachpoint 2 for Setpoint2
SP1 Dynamic Teach Start	0x47	Start dynamic teach-in for Setpoint1 NOTE
SP1 Dynamic Teach Stop	0x48	Stop dynamic teach-in for Setpoint1
SP2 Dynamic Teach Start	0x49	Start Dynamic teach-in for Setpoint2
SP2 Dynamic Teach Stop	0x4A	Stop Dynamic teach-in for Setpoint2 NOTE
Manufacturer Teach	0x4B to 0x4E	For manufacturer specific use
Teach Cancel	0x4F	Abort Teach-in sequence
NOTE	These commands shall be applied for the determination of both Setpoints SP1 and SP2 in one single teach-in procedure	

861

862 Table 15 shows the "Teach-in Channel" coding into Index 0x003A (reserved for profiles).

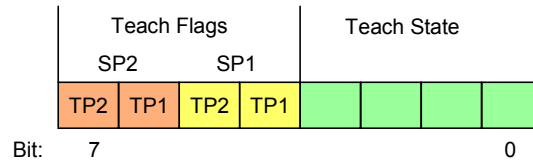
863

Table 15 – "Teach-in Channel" coding

Teach-in Channel	Definition
0	Address of the manufacturer/vendor specific pre-defined (default) BDC
1 to 128	Address of the BDC1 to BDC128
129 to 191	Reserved
192-254	Different manufacturer/vendor specific BDC sets
255	Addressing of all implemented BDCs

864

865 Figure 30 defines the data structure of the "Teach Flags" and the "Teach State" to be used in
866 the "Teach-in Status" coding in Table 13.



867

868

Figure 30 – Structure of the "Teach Flags" and the "Teach State"

869 Table 16 shows the "Teach State" coding.

870

Table 16 – "Teach State" coding

Teach State	Definition
0	IDLE
1	SP1 SUCCESS
2	SP2 SUCCESS
3	SP12 SUCCESS
4	WAIT FOR COMMAND
5	BUSY
6	RESERVED
7	ERROR
8 to 11	Reserved
12 to 15	Manufacturer/vendor specific

871

872 Table 17 shows the "Teach Flag" coding.

873

Table 17 – "Teach Flag" coding

Teach Flags	Comment
0	Teachpoint x not taught or not successful
1	Teachpoint x successfully taught

874

875
876
877

Annex A (normative) **Profile testing and conformity**

878 **A.1 General**

879 **A.1.1 Overview**

880 It is the responsibility of the vendor/manufacturer of a Smart Sensor profile Device to perform
881 a conformity testing and to provide a document similar to the manufacturer declaration de-
882 fined in [1] or based on the template downloadable from the IO-Link website ([www.io-](http://www.io-link.com)
883 [link.com](http://www.io-link.com)).

884 **A.1.2 Issues for testing/checking**

- 885 • Identification complete and correct?
- 886 • Descriptors available and correct?
- 887 • All rules observed?
- 888 • Switching behavior conform to the specification?
- 889 • FunctionClasses available and correct?
 - 890 - Indices available and correct?
 - 891 - Read/write correct?
 - 892 - Data structures: Record? Value ranges?
 - 893 - Behavior of the FunctionClass conforms to the specification?
- 894 • Extract BDCs (switching functions) from user manual or IODD and check conformity with
895 the specification
- 896 • Checklist: checkbox "relevant" and checkbox "verified"
- 897 • IODD: see [6]

898

899

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903
904

Annex B
(informative)
Information on conformity testing of profile Devices

905 Information about testing profile Devices for conformity with this document can be obtained
906 from the following organization:

907 **IO-Link Consortium**
908 Haid-und-Neu-Str. 7
909 76131 Karlsruhe
910 Germany
911 Phone: +49 (0) 721 / 96 58 590
912 Fax: +49 (0) 721 / 96 58 589
913 E-mail: info@io-link.com
914 Web site: <http://www.io-link.com>
915

916

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918 10.002 or IEC 61131-9, *Programmable controllers – Part 9: Single-drop digital communi-*
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- 920 [2] IO-Link Consortium, *IO Device Description (IODD)*, V1.1, July 2011, Order No. 10.012
- 921 [3] IEC/TR 62390:2005, *Common automation device profile guideline*
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923
- 924 NOTE See also the IEC Multilingual Dictionary – Electricity, Electronics and Telecommunications (available
925 on CD-ROM and at <<http://domino.iec.ch/iev>>).
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- 927 [6] IO-Link Consortium, *IO-Link Test Specification*, V1.1, May 2011, Order No. 10.032

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